

AMPMODU | AMPMODU Headers

TE Internal #: 5-102617-7

PCB Mount Header, Right Angle, Board-to-Board / Wire-to-Board,

18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



EU RoHS Compliance: Compliant
EU ELV Compliance: Compliant

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Right Angle

Connector System: Wire-to-Board, Board-to-Board

Features

Other

EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Wire-to-Board, Board-to-Board
Header Type	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Right Angle
Number of Positions	18
Number of Rows	2

Electrical Characteristics

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[Dielectric Withstanding Voltage (Max)	750 Vrms
I	Insulation Resistance	5000 MΩ

Body Features

Connector Profile	Standard
Primary Product Color	Black



Contact Features		
Contact Underplating Material	Nickel	
Contact Mating Area Plating Material Thickness	.381 μm[15 μin]	
Mating Square Post Dimension	.64 mm[.025 in]	
PCB Contact Termination Area Plating Material Thickness	2.54 – 5.08 μm[100 – 200 μin]	
Contact Shape & Form	Square	
Contact Base Material	Phosphor Bronze	
PCB Contact Termination Area Plating Material	Tin	
Contact Mating Area Plating Material	Gold	
Contact Type	Pin	
Contact Current Rating (Max)	3 A	
Termination Features		
Termination Post & Tail Length	3.43 mm[.135 in]	
Square Termination Post & Tail Dimension	.64 mm[.025 in]	
Termination Method to PCB	Through Hole - Solder	
Mechanical Attachment		
Mating Retention Type	Detent Window	
Mating Retention	With	
Mating Alignment Type	Polarization	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
Housing Features		
Housing Material	Thermoplastic	
Centerline (Pitch)	2.54 mm[.1 in]	
Dimensions		
Row-to-Row Spacing	2.54 mm[.1 in]	
PCB Thickness (Recommended)	1.4 mm[.055 in]	
Usage Conditions		
Housing Temperature Rating	Standard	

-65 – 105 °C[-85 – 221 °F]

Operating Temperature Range



Operation/Application

Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Compatible With Agency/Standards Products	CSA	
Compatible With Approved Standards Products	UL E28476, CSA LE7189	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	192	

Tray

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







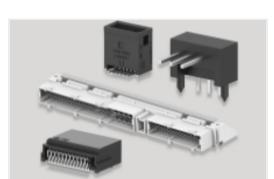
Also in the Series | AMPMODU Headers







Connector Hardware(1)



PCB Headers & Receptacles(1618)



Wire-to-Board Connector Assemblies & Housings(5)

Customers Also Bought

















Documents

CAD Files

Customer View Model ENG_CVM_5-102617-7_J.3d_igs.zip

English

Customer View Model ENG_CVM_5-102617-7_J.2d_dxf.zip

English

PCB Mount Header, Right Angle, Board-to-Board / Wire-to-Board, 18 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, AMPMODU Headers



3D PDF

English

Customer View Model

ENG_CVM_5-102617-7_J.3d_stp.zip

English

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Datasheets & Catalog Pages

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English